

JOURNAL OF ALLOYS AND COMPOUNDS

(Formerly Journal of the Less-Common Metals)

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Publication information: *Journal of Alloys and Compounds* (ISSN 0925-8388). For 2010, volumes 488–510 are scheduled for publication. Subscription prices are available upon request from the Publisher or from the Elsevier Customer Service Department nearest you or from this journal's website (<http://www.elsevier.com/locate/jallcom>). Further information is available on this journal and other Elsevier products through Elsevier's website (<http://www.elsevier.com>). Subscriptions are accepted on a prepaid basis only and are entered on a calendar year basis. Issues are sent by standard mail (surface within Europe, air delivery outside Europe). Priority rates are available upon request. Claims for missing issues should be made within six months of the date of dispatch.

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USA mailing notice: *Journal of Alloys and Compounds* (ISSN 0925-8388) is published semimonthly by Elsevier B.V. (Radarweg 29, 1043 NX Amsterdam, The Netherlands). Periodical postage paid at Rahway NJ and additional mailing offices.

USA POSTMASTER: Send change of address to *Journal of Alloys and Compounds*, Elsevier Customer Service Department, 3251 Riverport Lane, Maryland Heights, MO 63043, USA.

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